# onsemi

# **MOSFET** – N-Channel, SUPERFET<sup>®</sup> II, FRFET<sup>®</sup>

# **650 V, 54 A, 77 m**Ω

# FCH077N65F-F085

#### Description

SuperFET II MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently SuperFET II is very well suited for the Soft switching and Hard Switching topologies like High Voltage Full Bridge and Half Bridge DC–DC, Interleaved Boost PFC, Boost PFC for HEV–EV automotive.

SuperFET II FRFET MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

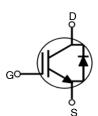
#### Features

- Typ.  $R_{DS(on)} = 68 \text{ m}\Omega$  at  $V_{GS} = 10 \text{ V}$ ,  $I_D = 27 \text{ A}$
- Typ.  $Q_{g(tot)} = 126 \text{ nC}$  at  $V_{GS} = 10 \text{ V}$ ,  $I_D = 27 \text{ A}$
- UIS Capability
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

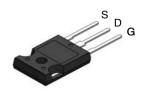
#### Applications

- Automotive On Board Charger
- Automotive DC/DC Converter for HEV

V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
650 V	77 m $\Omega$ @ 10 V	54 A

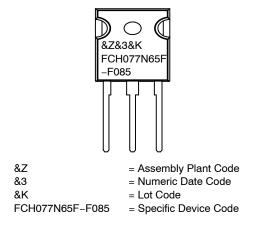


**N-CHANNEL MOSFET** 



TO-247-3LD CASE 340CK

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V <sub>DSS</sub>	Drain to Source Voltage	650	V
V <sub>GSS</sub>	Gate to Source Voltage	±20	V
Ι <sub>D</sub>	Drain Current – Continuous (V <sub>GS</sub> = 10) (Note 1)	54	А
	Pulsed Drain Current	See Fig. 4	А
E <sub>AS</sub>	Single Pulsed Avalanche Rating (Note 2)	1128	mJ
dv/dt	MOSFET dv/dt	100	V/ns
	Peak Diode Recovery dv/dt (Note 3)	50	1
PD	Power Dissipation	481	W
	Derate Above 25°C	3.85	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	–55 to + 150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Current is limited by bondwire configuration.

2. Starting  $T_J = 25$  °C, L = 18.65 mH, I<sub>AS</sub> = 11 A, V<sub>DD</sub> = 100 V during inductor charging and V<sub>DD</sub> = 0 V during time in avalanche. 3. I<sub>SD</sub>  $\leq$  27 A, di/dt  $\leq$  200 A/µs, V<sub>DD</sub>  $\leq$  380 V, starting  $T_J = 25$  °C.

#### PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCH077N65F	FCH077N65F-F085	TO-247-3	-	-	30 Units

#### **THERMAL CHARACTERISTICS**

Symbol	Symbol Parameter		Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.26	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max. (Note 4)	40	

4. R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design, while  $R_{\theta JA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.



#### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition		Min.	Тур.	Max.	Unit		
OFF CHARA	ACTERISTICS								
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu\text{A}, \ V_{GS}$	= 0 V	650	-	-	V		
I <sub>DSS</sub>	Drain to Source Leakage Current	$V_{DS} = 650 V,$ $V_{GS} = 0 V$	T <sub>J</sub> = 25 °C	-	-	10	μA		
		$V_{GS} = 0 V$	T <sub>J</sub> = 150 °C (Note 5)	-	-	1	mA		
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±20 V	<u>.</u>	-	-	±100	nA		
	N CHARACTERISTICS								

#### ON CHARACTERISTICS

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 2$	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$		-	5	V
R <sub>DS(on)</sub>	Drain to Source On Resistance	$I_{\rm D} = 27 \rm{A}$	$T_J = 25 \ ^{\circ}C$	-	68	77	mΩ
		V <sub>GS</sub> = 10 V	T <sub>J</sub> = 150 °C (Note 5)	-	154	184	mΩ

#### DYNAMIC CHARACTERISTICS

C <sub>iss</sub>	Input Capacitance	$V_{\rm DS} = 25 \text{ V}, V_{\rm GS} = 0 \text{ V},$	-	5385	7162	pF
C <sub>oss</sub>	Output Capacitance	f = 1 MHz	-	5629	7486	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	194	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 520 V, $V_{GS}$ = 0 V	-	693	_	pF
Rg	Gate Resistance	f = 1 MHz	-	0.5	-	Ω
Q <sub>g(tot)</sub>	Total Gate Charge	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 27 \text{ A}, V_{GS} = 10 \text{ V}$	-	126	164	nC
Q <sub>g(th)</sub>	Threshold Gate Charge	V <sub>GS</sub> = 10 V	-	9	12	nC
Q <sub>gs</sub>	Gate to Source Gate Charge		-	28	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller"Charge	]	-	53	-	nC

#### SWITCHING CHARACTERISTICS

t <sub>on</sub>	Turn-On Time	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 27 \text{ A},$	-	64	148	ns
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$	-	37	_	ns
t <sub>r</sub>	Rise Time		-	27	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	105	-	ns
t <sub>f</sub>	Fall Time		-	5.3	-	ns
t <sub>off</sub>	Turn-Off Time		-	108.3	237	ns

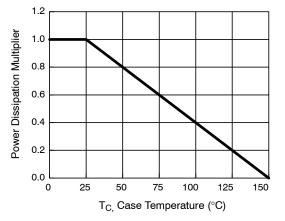
#### **DRAIN-SOURCE DIODE CHARACTERISTICS**

	$V_{SD}$	Source to Drain Diode Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 27 \text{ A}$	-	-	1.2	V
	t <sub>rr</sub>	Reverse Recovery Time	$V_{DD} = 520 \text{ V}, \text{ I}_{\text{F}} = 27 \text{ A},$	-	190	-	ns
ſ	Q <sub>rr</sub>	Reverse Recovery Charge	di <sub>SD</sub> /dt = 100 A/µs	-	1.5	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. The maximum value is specified by design at  $T_J = 150^{\circ}$ C. Product is not tested to this condition in production.



#### **TYPICAL CHARACTERISTICS**





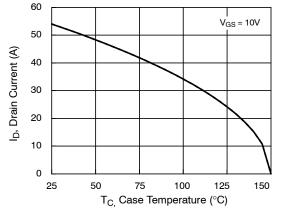


Figure 2. Maximum Continuous Drain Current vs. Case Temperature

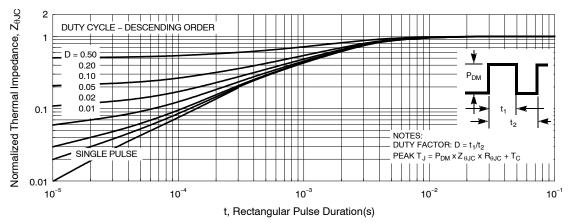
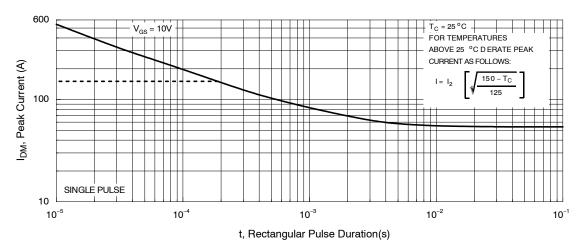


Figure 3. Normalized Maximum Transient Thermal Impedance





#### **TYPICAL CHARACTERISTICS**

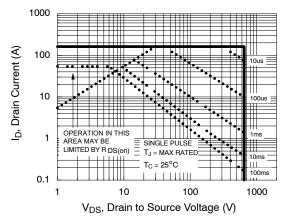


Figure 5. Forward Bias Safe Operating Area

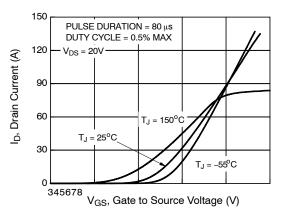


Figure 6. Transfer Characteristics

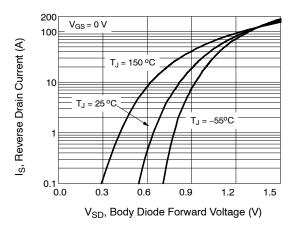
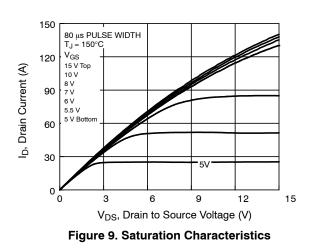
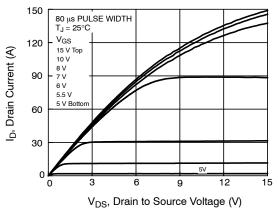
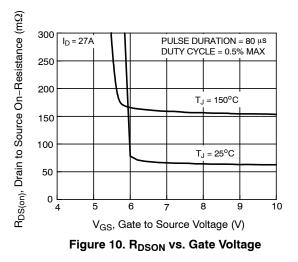


Figure 7. Forward Diode Characteristics









#### **TYPICAL CHARACTERISTICS**

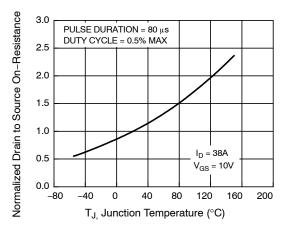


Figure 11. Normalized R<sub>DSON</sub> vs. Junction Temperature

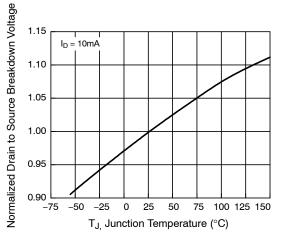


Figure 13. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

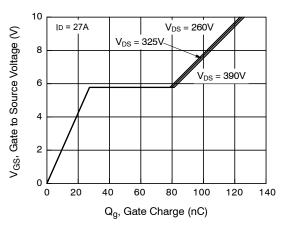


Figure 15. Gate Charge vs. Gate to Source Voltage

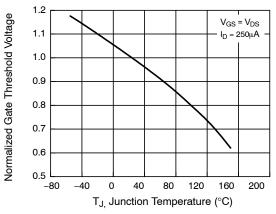


Figure 12. Normalized Gate Threshold Voltage vs. Temperature

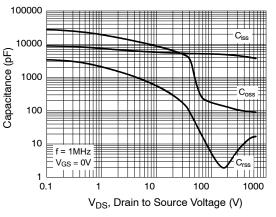


Figure 14. Capacitance vs. Drain to Source Voltage

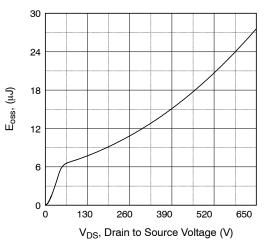
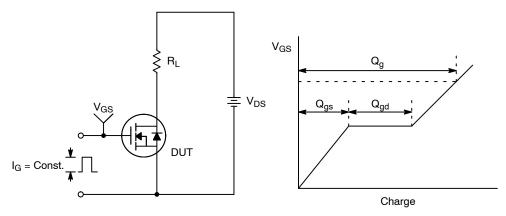


Figure 16. Eoss vs. Drain to Source Voltage







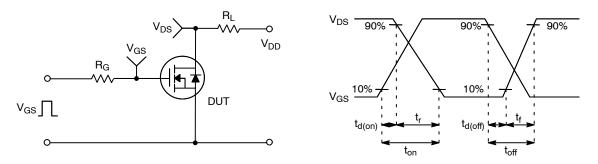
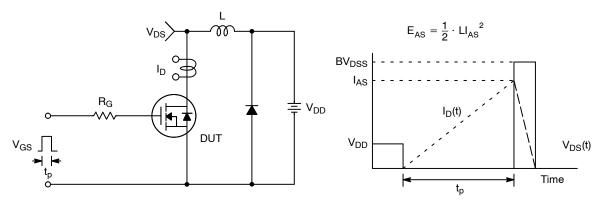


Figure 18. Resistive Switching Test Circuit & Waveforms







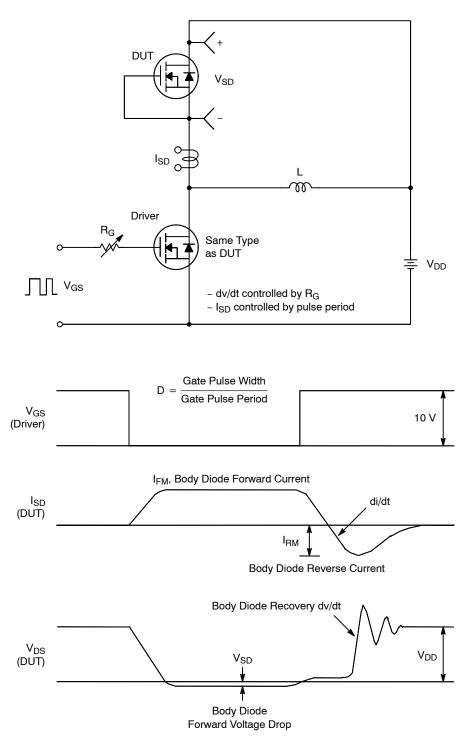


Figure 20. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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TO-247-3LD SHORT LEAD CASE 340CK **ISSUE A** 

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